

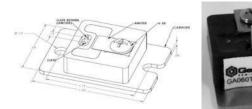
Silicon Carbide Thyristor

GA060TH65

Carbiac	

V _{FBM}	=	6500 V
I _{T(AVM)}	=	60 A
Q _{rr}	=	2.95 µC

Package





Features

- 6500 V Asymmetric SiC NPNP Thyristor
- 150 °C operating temperature
- Robust compact fully soldered package
- SOT-227 (ISOTOP) base plate form factor
- Fast turn on characteristics
- Lowest in class $Q_{rr}/I_{T(AVM)}$

Applications

- Grid Tied Solar Inverters
- Wind Power Inverters
- HVDC Power Conversion
- Utility Scale Power Conversion
- Trigger Circuits/Ignition Circuits

Maximum Ratings

Parameter	Symbol	Conditions	Values	Unit
Repetitive peak forward voltage	V _{FBM}	T _j = 25 °C	6500	V
Repetitive peak reverse voltage	V _{RBM}	T _j = 25 °C	50	V
Maximum average on-state current	I _{T(AVM)}	T _c ≤ 120 °C	60	А
RMS on-state current	I _{T(RMS)}	T _c ≤ 120 °C	104	А
Non-repetitive peak on-state current	I _{T,max}	T_c = 25 °C, t_p = 2 us, D = 0.1	tbd	А
Power dissipation	P _{tot}	T _c = 25 °C	919	W
Operating and storage temperature	T _j , T _{stg}		-55 to 150	°C

Electrical Characteristics

Parameter	Symbol	Conditions	Values		11	
			min.	typ.	max.	Unit
Maximum peak on state voltage	V	I _κ = -60 A, T _j = 25 °C		-3.90		V
	V _{KA(ON)}	I _κ = -60 A, Τ _j = 150 °C		-3.70		
Anode-cathode threshold voltage	V _{KA(TO)}	T _j = 25 °C (150 °C)		-3.1(-2.8)		V
Anode-cathode slope resistance	R _{AK}	T _j = 25 °C (150 °C), I _κ = -60 A		9.4(9.5)		mΩ
	I	V _{KA} = -6500 V, V _{GA} = 0 V, T _i = 25 °C		20		
Leakage current	L	V _{KA} = -6500 V, V _{GA} = 0 V, T _j = 150 °C		50		μA
Gate trigger current	Ι _{στ}	$T_{j} = 25 \text{ °C}, t_{p} = 10 \mu\text{s}$		-100		mA
Holding current	I _H	T _i = 25 °C		tbd		mA
Rise time	t _R	I _G = -3 A, V _{KA} = -2200 V		170		ns
Delay time	t _D	I _κ = -60 A, T _i = 25 °C		45		ns
Reverse recovery charge	Q _{rr}	·		2.95		μC
Recovered charge, 50% chord	Q _{ra}	dI/dt = 360 A/us, I_{κ} = -60 A, $V_{\kappa A}$ = 20 V		1.6		μC
Reverse recovery current	I _{rm}	dV/dt(re-app) = -362 V/us, T _i = 25 °C		15		А
Circuit commutated turn-off time	t _q	-		6.7		μs
Thermal Characteristics						
Thermal resistance, junction - case	R _{thJC}			0.136		°C/W

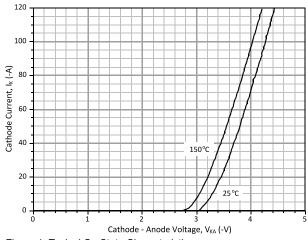
Mechanical Properties				
Mounting torque for base	M _b	Heat sink surface must be optically flat	1.5	Nm
Mounting torque for top	M _t		1.3	Nm
Weight	W.		30	a

1. Considering worst case Z_{th} conditions

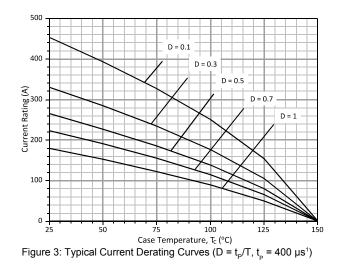
http://www.genesicsemi.com/index.php/sic-products/thyristors



GA060TH65







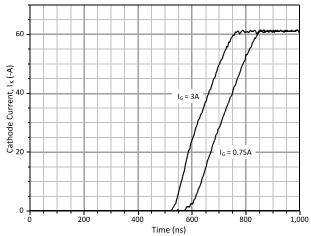


Figure 5: Typical Turn On Characteristics at 25 °C

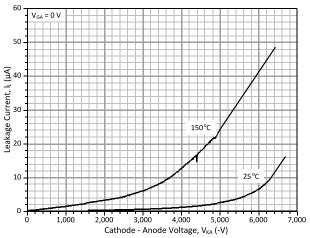
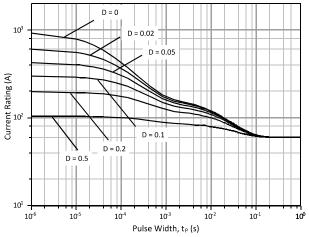
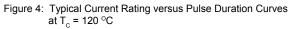


Figure 2: Typical Forward Blocking Characteristics





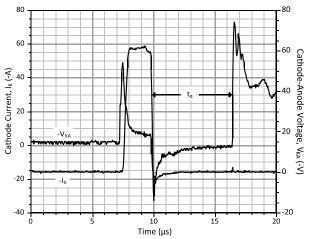


Figure 6: Typical Turn Off Characteristics at 25 °C

Preliminary Datasheet http://www.genesicsemi.com

GA060TH65



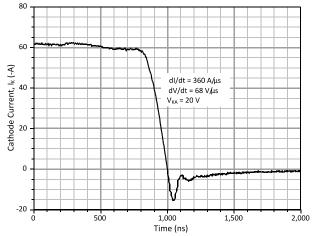


Figure 7: Typical Reverse Recovery Characteristics at 25 °C

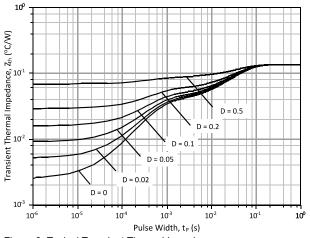


Figure 8: Typical Transient Thermal Impedance

Revision History				
Date	Revision	Comments	Supersedes	
2010/11/10	1	First generation release		

Published by GeneSiC Semiconductor, Inc. 43670 Trade Center Place Suite 155 Dulles, VA 20166

GeneSiC Semiconductor, Inc. reserves right to make changes to the product specifications and data in this document without notice.

GeneSiC disclaims all and any warranty and liability arising out of use or application of any product. No license, express or implied to any intellectual property rights is granted by this document.

Unless otherwise expressly indicated, GeneSiC products are not designed, tested or authorized for use in life-saving, medical, aircraft navigation, communication, air traffic control and weapons systems, nor in applications where their failure may result in death, personal injury and/or property damage.